503447491 08/21/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3494116

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MAHESH WAGH	04/27/2015
ZUOGUO WU	03/26/2015
VENKATRAMAN IYER	03/26/2015
GERALD S. PASDAST	08/12/2015
MARK S. BIRRITTELLA	04/03/2015
ISHWAR AGARWAL	03/26/2015
LIP KHOON TEH	04/01/2015
SU WEI LIM	08/17/2015
ANOOP KUMAR UPADHYAY	04/29/2015

RECEIVING PARTY DATA

Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BOULEVARD
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14669975

CORRESPONDENCE DATA

Fax Number: (972)226-4837

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

using a lax number, if provided, if that is unsuccessful, it will be sent via

Phone: (214) 823-1241

Email: dellagonzales@patcapgroup.com

Correspondent Name: SEAN C. CRANDALL
Address Line 1: 2816 LAGO VISTA LANE
Address Line 2: PATENT CAPITAL GROUP
Address Line 4: ROCKWALL, TEXAS 75032

ATTORNEY DOCKET NUMBER: P73735

NAME OF SUBMITTER: SEAN C. CRANDALL

503447491 REEL: 036394 FRAME: 0916

SIGNATURE:	/Sean C. Crandall/		
DATE SIGNED:	08/21/2015		
Total Attachments: 10	Total Attachments: 10		
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PATENT REEL: 036394 FRAME: 0917

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Mahesh Wagh, Zuoguo Wu, Venkatraman Iyer, Gerald S. Pasdast, Mark S. Birrittella, Ishwar Agarwal, Lip Khoon Teh, Su Wei Lim, Anoop Kumar Upadhyay

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

MULTICHIP PACKAGE LINK

designated lines below, the filing date and application number of said application when known.)			
which was filed on March 26, 201	5		as
US COUNTRY or International Office	Application Number	14/669,975	and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and

<u> </u>	4/27/2015
Mahesh Wagh	Date signed
Zuoguo Wu	Date signed
Venkatraman lyer	Date signed
Gerald S. Pasdast	Date signed
Mark S. Birrittella	Date signed
ishwar Agarwai	Date signed
Lip Khoon Teh	Date signed
Sa Wei Lim	Date signed
Anoop Kumar Upadhyay	Date signed

maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Mahesh Wagh	Date signed
Znoguo Wu	3/26/2015
Zuoguo Wu	Date signed
Venkatraman lyer	Date signed
Gereld S. Pasdast	Date signed
Mark S. Birrittella	Date signed
Ishwar Agarwal	Date signed
Lip Khoon Teh	Date signed
Su Wei Lim	Date signed
Anoop Kumar Upadhyay	Date signed

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	Mahesh Wagh		Date signed
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	Venkatraman lyer		Date signed
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	Gerald S. Pasdast		Date signed
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***************************************	Anoop Kumar Upadhyay		Date signed

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Page 2 of 2

Lip Khoon Teh

Su Wei Lim

Anoop Kumar Upadhyay

Date signed

Date signed

Date signed

Mahesh Wagh	Date signed
Zuoguo Wu	Date signed
Venkatraman Iyer	Date signed
Gerald S. Pasdast	Date signed
Was I Smithly	4/3/2015
Mark S. Birrittella	Date signed
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Anoop Kumar Upadhyay	Date signed

Mahesh Wagh	Date signed
Zuoguo Wu	Date signed
Venkatraman Iyer	Date signed
Gerald S. Pasdast	Date signed
Mark S. Birrittella /*** ** / * Ishwar Agarwal	Date signed 03 24/15 Date signed
Lip Khoon Teh	Date signed
Su Wei Lim	Date signed
Anoop Kumar Upadhyay	Date signed

maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

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Venkatraman Iyer	Date signed
Gerald S. Pasdast	Date signed
Mark S. Birrittella	Date signed
Ishwar Agarwal	Date signed 4/1/2015
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covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Mahesh Wagh	Date signed
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Venkatraman İyer	Date signed
Gerald S. Pasdast	Date signed
Mark S. Birrittella	Date signed
Ishwar Agarwal	Date signed
Lip Khoon Teh	Date signed
	(3/8/15
Su Wei Lim	Date signed
Anoop Kumar Upadhyay	Date signed

Page 2 of 2

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Gerald S. Pasdast	Date signed
Mark S. Birrittella	Date signed
Ishwar Agarwal	Date signed
Lip Khoon Teh	Date signed
Su Wei Lim	Date signed
- A-R	A0ril 24, 2015. Date Signed
Anoop Kumar Upadhyay	Date Signed

Page 2 of 2